

RM 7, RM 7 LP Core and accessories

Series/Type: B65819, B65820, B65659

Date: February 2024

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Core and accessories

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	- Adjusting screw	B65659	7
	Core	B65819	3
	Clamps	B65820	6
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	Core	B65819	3
	Threaded sleeve (glued-in)		
FRM0050-W	Insulating washer	B65820	6
Example of an assembly set			
Also available:	RM 7 low profile:		
	Core	B65819P	7



Core B65819

■ To IEC 63093-4

 Core without center hole for transformer applications

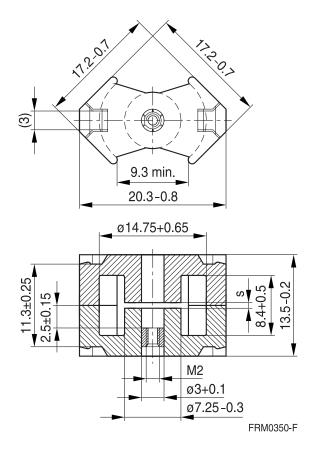
■ Delivery mode: sets

Magnetic characteristics (per set)

	with center hole	without center hole	
ΣΙ/Α	0.75	0.7	mm ⁻¹
l _e	29.8	30.4	mm
l _e A _e A _{min}	40	43	mm ²
A_{min}		39	mm ²
V _e	1190	1310	mm ³

Approx. weight (per set)

m	6.5	7.2	g



Gapped (A_L values/air gaps examples)

Material	A _L value	s approx. mm	μ _e	Ordering code ¹⁾ -A with center hole -N with threaded sleeve -J without center hole
N41	160 ±5%	0.30	90	B65819J0160J041
	250 ±5%	0.18	141	B65819J0250J041
N48	250 ±3%	0.16	148	B65819+0250A048
	315 ±3%	0.12	187	B65819+0315A048

¹⁾ Replace the + by the code letter "A", "N" or "J" for the required version.



RM 7 Core B65819

Ungapped

Material	A _L value	μ _e	P _V	Ordering code
	nH		W/set	-J without center hole
PC200 ¹⁾	950 +30/–20%	530	< 0.40 (50 mT, 1000 kHz, 100 °C) < 0.50 (30 mT, 2000 kHz, 100 °C)	B65819E0000R608
N30	5000 +30/–20%	2810		B65819J0000R030
T38	10000 +40/-30%	5630		B65819J0000Y038
N49	1900 +30/–20%	1070	< 0.22 (50 mT, 500 kHz, 100 °C)	B65819J0000R049
N87	2700 +30/–20%	1520	< 0.77 (200 mT, 100 kHz, 100 °C)	B65819J0000R087
N97	2700 +30/–20%	1520	< 0.58 (200 mT, 100 kHz, 100 °C)	B65819J0000R097
N95	3300 +30/–20%	1860	< 0.65 (200 mT, 100 kHz, 100 °C) < 0.70 (200 mT, 100 kHz, 25 °C)	B65819J0000R095

¹⁾ Preliminary data

Other A_L values/air gaps and materials available on request — see Processing remarks on page 9.



Accessories B65820

Coil former

Material: GFR thermosetting plastic (UL 94 V-0, insulation class to IEC 60085:

F

max. operating temperature 155 °C), color code black

Sumikon PM 9630® [E41429 (M)], SUMITOMO BAKELITE CO LTD

Solderability: to IEC 60068-2-20, test Ta, method 1 (aging 3): 235 °C, 2 s

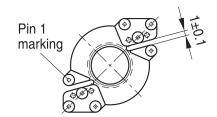
Resistance to soldering heat: to IEC 60068-2-20, test Tb, method 1B: 350 °C, 3.5 s

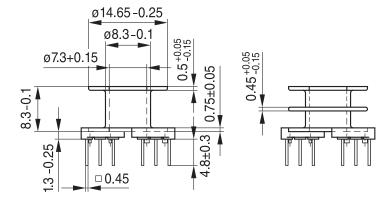
Winding: see Processing notes, 2.1

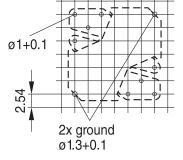
Pins: Squared pins

For matching clamp and insulating washers see page 6.

Sections	A _N mm ²	I _N mm	A_R value $\mu\Omega$	Pins	Ordering code
1	22.4	36.0	55.4	8	B65820W1008D001
2	21.9	36.0	56.5	8	B65820W1008D002







Hole arrangement View in mounting direction

FRM0421-5-E



Accessories B65820

Clamp

- With ground terminal, made of spring steel (tinned), 0.4 mm thick
- Solderability to IEC 60068-2-20, test Ta, method 1 (aging 3): 235 °C, 2 s

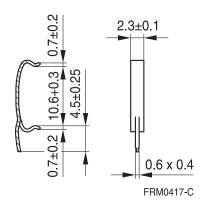
Insulating washer for double-clad PCBs

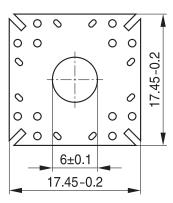
■ Made of polycarbonate (UL 94 V-0, insulation class to IEC 60085: E 120 °C), 0.25 mm thick Makrofol FR7-2 [E168120 (M)], COVESTRO AG

	Ordering code
Clamp (ordering code per piece, 2 are required)	B65820B2001X000
Insulating washer (bulk)	B65820D2005X000

Clamp

Insulating washer





FRM0092-7



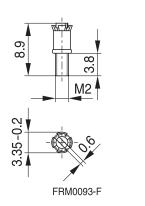
Accessories B65659

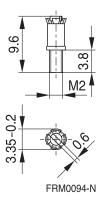
Adjusting screw

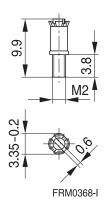
■ Tube core with thread and core brake made of GFR polyterephthalate Pocan B3235® [E245249 (M)], LANXESS AG

Figure	Tube core Ø × length (mm)	Material	Color code	Ordering code
a	2.62 × 3.6	N22	red	B65659F0001X023
b	2.75 × 4.4	N22	black	B65659F0003X023
С	2.82 × 4.4	N22	yellow	B65659F0004X023

a b c









RM 7 »Low Profile«

Core B65819P

■ To IEC 63093-4

For compact transformers

■ Without center hole

■ Delivery mode: sets

Magnetic characteristics (per set)

 $\Sigma I/A = 0.52 \text{ mm}^{-1}$

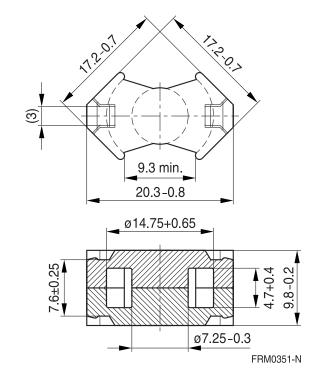
= 23.5 mm

 $A_e = 45.3 \text{ mm}^2$

 $A_{min} = 39.6 \text{ mm}^2$

 $V_e = 1060 \text{ mm}^3$

Approx. weight 5.7 g/set



Ungapped

Material	A _L value	μ_{e}	P _V	Ordering code
	nH		W/set	
T38	11500 +40/–30%	4750		B65819P0000Y038
N49	2400 +30/–20%	990	< 0.21 (50 mT, 500 kHz, 100 °C)	B65819P0000R049
N92	2600 +30/–20%	1070	< 0.63 (200 mT, 100 kHz, 100 °C)	B65819P0000R092
N87	3300 +30/–20%	1360	< 0.57 (200 mT, 100 kHz, 100 °C)	B65819P0000R087

Other A_I values/air gaps and materials available on request — see Processing remarks on page 9.



Cautions and warnings

Mechanical stress and mounting

Ferrite cores have to meet mechanical requirements during assembling and for a growing number of applications. Since ferrites are ceramic materials one has to be aware of the special behavior under mechanical load.

As valid for any ceramic material, ferrite cores are brittle and sensitive to any shock, fast temperature changing or tensile load. Especially high cooling rates under ultrasonic cleaning and high static or cyclic loads can cause cracks or failure of the ferrite cores.

For detailed information see data book, chapter "General - Definitions, 8.1".

Effects of core combination on A₁ value

Stresses in the core affect not only the mechanical but also the magnetic properties. It is apparent that the initial permeability is dependent on the stress state of the core. The higher the stresses are in the core, the lower is the value for the initial permeability. Thus the embedding medium should have the greatest possible elasticity.

For detailed information see data book, chapter "General - Definitions, 8.1".

Heating up

Ferrites can run hot during operation at higher flux densities and higher frequencies.

NiZn-materials

The magnetic properties of NiZn-materials can change irreversible in high magnetic fields.

Ferrite Accessories

Our ferrite accessories have been designed and evaluated only in combination with our ferrite cores. We explicitly point out that our ferrite accessories or our ferrite cores may not be compatible with those of other manufacturers. Any such combination requires prior testing by the customer and will be at the customer's own risk.

We assume no warranty or reliability for the combination of our ferrite accessories with cores and other accessories from any other manufacturer.

Processing remarks

The start of the winding process should be soft. Else the flanges may be destroyed.

- Too strong winding forces may blast the flanges or squeeze the tube that the cores can not be mounted any more.
- Too long soldering time at high temperature (>300 °C) may effect coplanarity or pin arrangement.
- Not following the processing notes for soldering of the J-leg terminals may cause solderability problems at the transformer because of pollution with Sn oxyde of the tin bath or burned insulation of the wire. For detailed information see chapter "Processing notes", section 2.2.
- The dimensions of the hole arrangement have fixed values and should be understood as a recommendation for drilling the printed circuit board. For dimensioning the pins, the group of holes can only be seen under certain conditions, as they fit into the given hole arrangement. To avoid problems when mounting the transformer, the manufacturing tolerances for positioning the customers' drilling process must be considered by increasing the hole diameter.

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Cautions and warnings

Display of ordering codes for TDK Electronics products

The ordering code for one and the same product can be represented differently in data sheets, data books, other publications, on the company website or in order-related documents such as shipping notes, order confirmations and product labels. The varying representations of the ordering codes are due to different processes employed and do not affect the specifications of the respective products. Detailed information can be found on the Internet under www.tdk-electronics.tdk.com/orderingcodes.

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Symbols and terms

Symbol	Meaning	Unit
A	Cross section of coil	mm ²
A_{e}	Effective magnetic cross section	mm ²
A_L	Inductance factor; A _L = L/N ²	nH
A_{L1}	Minimum inductance at defined high saturation ($\triangleq \mu_a$)	nH
A_{min}	Minimum core cross section	mm ²
A_N	Winding cross section	mm ²
A_R	Resistance factor; $A_R = R_{Cu}/N^2$	$\mu\Omega = 10^{-6} \Omega$
В	RMS value of magnetic flux density	Vs/m ² , mT
ΔΒ	Flux density deviation	Vs/m ² , mT
Ê	Peak value of magnetic flux density	Vs/m ² , mT
Δ Ĝ	Peak value of flux density deviation	Vs/m ² , mT
B_DC	DC magnetic flux density	Vs/m², mT
B _R	Remanent flux density	Vs/m ² , mT
B_S	Saturation magnetization	Vs/m ² , mT
C_0	Winding capacitance	F = As/V
CDF	Core distortion factor	mm ^{-4.5}
DF	Relative disaccommodation coefficient DF = d/μ_i	
d	Disaccommodation coefficient	
E_a	Activation energy	J
f	Frequency	s−1, Hz
f _{cutoff}	Cut-off frequency	s ^{−1} , Hz
f _{max}	Upper frequency limit	s−1, Hz
f _{min}	Lower frequency limit	s ^{−1} , Hz
f _r	Resonance frequency	s ^{−1} , Hz
f _{Cu}	Copper filling factor	
g	Air gap	mm
H	RMS value of magnetic field strength	A/m
Ĥ	Peak value of magnetic field strength	A/m
H_{DC}	DC field strength	A/m
H _c	Coercive field strength	A/m
h	Hysteresis coefficient of material	10 ⁻⁶ cm/A
h/μ_i^2	Relative hysteresis coefficient	10 ⁻⁶ cm/A
1	RMS value of current	Α
I_{DC}	Direct current	Α
î	Peak value of current	Α
J	Polarization	Vs/m ²
k	Boltzmann constant	J/K
k_3	Third harmonic distortion	
k _{3c}	Circuit third harmonic distortion	
L	Inductance	H = Vs/A



Symbols and terms

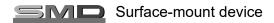
Symbol	Meaning	Unit
ΔL/L	Relative inductance change	Н
L_0	Inductance of coil without core	Н
L _H	Main inductance	Н
L_p	Parallel inductance	Н
L _{rev}	Reversible inductance	Н
L _s	Series inductance	Н
l _e	Effective magnetic path length	mm
I _N	Average length of turn	mm
N	Number of turns	
P_{Cu}	Copper (winding) losses	W
P _{trans}	Transferrable power	W
P_V	Relative core losses	mW/g
PF	Performance factor	
Q	Quality factor (Q = ω L/R _s = 1/tan δ _L)	
R	Resistance	Ω
R_{Cu}	Copper (winding) resistance (f = 0)	Ω
R_h	Hysteresis loss resistance of a core	Ω
ΔR_h	R _h change	Ω
R_i	Internal resistance	Ω
R_p	Parallel loss resistance of a core	Ω
R _s	Series loss resistance of a core	Ω
R_{th}	Thermal resistance	K/W
R_V	Effective loss resistance of a core	Ω
S	Total air gap	mm
T	Temperature	°C
ΔT	Temperature difference	K
T_{C}	Curie temperature	°C
t	Time	s
t_{v}	Pulse duty factor	
tan δ	Loss factor	
tan δ_{L}	Loss factor of coil	
tan δ_r	(Residual) loss factor at $H \rightarrow 0$	
tan δ_e	Relative loss factor	
tan δ_h	Hysteresis loss factor	
tan δ/μ _i	Relative loss factor of material at $H \rightarrow 0$	
U	RMS value of voltage	V
Û	Peak value of voltage	V
V_e	Effective magnetic volume	mm ³
Z	Complex impedance	Ω
Z_{n}	Normalized impedance $ Z _n = Z / N^2 \times \varepsilon (I_e / A_e)$	Ω/mm



Symbols and terms

Symbol	Meaning	Unit
α	Temperature coefficient (TK)	1/K
α_{F}	Relative temperature coefficient of material	1/K
α_{e}	Temperature coefficient of effective permeability	1/K
r	Relative permittivity	
Þ	Magnetic flux	Vs
1	Efficiency of a transformer	
В	Hysteresis material constant	mT-1
li	Hysteresis core constant	$A^{-1}H^{-1/2}$
'S	Magnetostriction at saturation magnetization	
,	Relative complex permeability	
0	Magnetic field constant	Vs/Am
a	Relative amplitude permeability	
арр	Relative apparent permeability	
е	Relative effective permeability	
i	Relative initial permeability	
p'	Relative real (inductive) component of $\overline{\mu}$ (for parallel components)	
p"	Relative imaginary (loss) component of $\overline{\mu}$ (for parallel components)	
r	Relative permeability	
rev	Relative reversible permeability	
s'	Relative real (inductive) component of $\overline{\mu}$ (for series components)	
s"	Relative imaginary (loss) component of $\overline{\mu}$ (for series components)	
tot	Relative total permeability	
	derived from the static magnetization curve	
	Resistivity	Ω m $^{-1}$
I/A	Magnetic form factor	mm ⁻¹
Cu	DC time constant $\tau_{Cu} = L/R_{Cu} = A_L/A_R$	s
)	Angular frequency; ω = 2 Π f	s ⁻¹

All dimensions are given in mm.





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The following applies to all products named in this publication:

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